## ITU CO/Loop Carrier SLIC

The HC-5509B telephone Subscriber Line Interface Circuit integrates most of the BORSCHT functions on a monolithic IC. The device is manufactured in a Dielectric Isolation (DI) process and is designed for use as a high voltage interface between the traditional telephone subscriber pair (Tip and Ring) and the low voltage filtering and coding/decoding functions of the line card. Together with a secondary protection diode bridge and "feed" resistors, the device will withstand 1000 V lightning induced surges, in plastic packages. The SLIC also maintains specified transmission performance in the presence of externally induced longitudinal currents. The BORSCHT functions that the SLIC provides are:

Battery Feed with Subscriber Loop Current Limiting

- Overvoltage Protection
- Ring Relay Driver
- Supervisory Signaling Functions
- Hybrid Functions (with External Op Amp)
- Test (or Battery Reversal) Relay Driver

In addition, the SLIC provides selective denial of power to subscriber loops, a programmable subscriber loop current limit from 20 mA to 60 mA , a thermal shutdown with an alarm output and line fault protection. Switch hook detection, ring trip detection and ground key detection functions are also incorporated in the SLIC device.

The HC-5509B SLIC is ideally suited for line card designs in PBX and CO systems, replacing traditional transformer solutions.

## Ordering Information

| PART <br> NUMBER | TEMP.RANGE <br> $\left({ }^{\circ} \mathrm{C}\right)$ | PACKAGE | PKG. NO. |
| :--- | :---: | :--- | :--- |
| HC3-5509B-5 | 0 to 75 | 28 Ld PDIP | E28.6 |
| HC3-5509B-9 | -40 to 85 | 28 Ld PDIP | E28.6 |
| HC4P5509B-5 | 0 to 75 | 44 Ld PLCC | N44.65 |
| HC4P5509B-9 | -40 to 85 | 44 Ld PLCC | N44.65 |
| HC9P5509B-5 | 0 to 75 | 28 Ld SOIC | M28.3 |
| HC9P5509B-9 | -40 to 85 | 28 Ld SOIC | M28.3 |

## Features

- DI Monolithic High Voltage Process
- Compatible with Worldwide PBX and CO Performance Requirements
- Controlled Supply of Battery Feed Current with Programmable Current Limit
- Operates with 5V Positive Supply ( $\mathrm{V}_{\mathrm{B}_{+}}$)
- Internal Ring Relay Driver and a Utility Relay Driver
- High Impedance Mode for Subscriber Loop
- High Temperature Alarm Output
- Low Power Consumption During Standby Functions
- Switch Hook, Ground Key, and Ring Trip Detection
- Selective Power Denial to Subscriber
- Voice Path Active During Power Denial
- On-Chip Op Amp for 2-Wire Impedance Matching


## Applications

- Solid State Line Interface Circuit for PBX or Central Office Systems, Digital Loop Carrier Systems
- Hotel/Motel Switching Systems
- Direct Inward Dialing (DID) Trunks
- Voice Messaging PBXs
- High Voltage 2-Wire/4-Wire, 4-Wire/2-Wire Hybrid
- Related Literature
- AN9607, Impedance Matching Design Equations
- AN9628, AC Voltage Gain
- AN9608, Implementing Pulse Metering
- AN549, The HC-5502S/4X Telephone Subscriber Line Interface Circuits (SLIC)

| Absolute Maximum Ratings (Note 1) |  |
| :---: | :---: |
| Relay Drivers | -0.5 V to 15 V |
| Maximum Supply Voltages |  |
| $\left(\mathrm{V}_{\mathrm{B}+}\right)$ | -0.5V to 7 V |
| $\left(\mathrm{V}_{\mathrm{B}_{+}}\right)$-( $\mathrm{V}_{\mathrm{B}-}$ ) | 75 V |
| Operating Conditions |  |
| Operating Temperature Range |  |
| HC-5509B-5 | .$^{\circ} \mathrm{C}$ to $75^{\circ} \mathrm{C}$ |
| HC-5509B-9 | $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ |
| Relay Drivers | 5 V to 12 V |
| Positive Power Supply ( $\mathrm{V}_{\mathrm{B}_{+}}$) | $5 \mathrm{~V} \pm 5 \%$ |
| Negative Power Supply ( $\mathrm{V}_{\mathrm{B}}$ ) ) | -42V to -58V |
| Loop Resistance ( $\mathrm{R}_{\mathrm{L}}$ ) | $750 \Omega$ (Note 2) |

## Thermal Information

| Thermal Resistance (Typical, Note 3) | $\theta_{\text {JA }}\left({ }^{\circ} \mathrm{C} / \mathrm{W}\right)$ | $\theta_{\text {JC }}\left({ }^{\circ} \mathrm{C} / \mathrm{W}\right)$ |
| :---: | :---: | :---: |
| CERDIP Package. | 48 | 12 |
| PDIP Package | 51 | N/A |
| PLCC Package. | 47 | N/A |
| SOIC Package | 72 | N/A |
| Maximum Junction Temperature Ceramic |  | $.175{ }^{\circ} \mathrm{C}$ |
| Maximum Junction Temperature Plastic |  | $.150^{\circ} \mathrm{C}$ |
| Storage Temperature Range |  | to $150^{\circ} \mathrm{C}$ |
| Maximum Lead Temperature (Soldering |  | $.300^{\circ}$ |

(For SMD; PLCC and SOIC - Lead Tips Only)

## Die Characteristics

Transistor Count. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 224
Diode Count. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 28
Die Dimensions . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $174 \times 120$
Substrate Potential. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . Connected
Process . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . Bipolar-DI

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.
NOTES:

1. Absolute maximum ratings are limiting values, applied individually, beyond which the serviceability of the circuit may be impaired. Functional operability under any of these conditions is not necessarily implied.
2. May Be Extended to $1900 \Omega$ With Application Circuit.
3. $\theta_{J A}$ is measured with the component mounted on an evaluation PC board in free air.

Electrical Specifications Unless Otherwise Specified, Typical Parameters are at $T_{A}=25^{\circ} \mathrm{C}$, Min-Max Parameters are Over Operating Temperature Range, $\mathrm{V}_{\mathrm{B}-}=-48 \mathrm{~V}, \mathrm{~V}_{\mathrm{B}+}=5 \mathrm{~V}, \mathrm{AG}=\mathrm{DG}=\mathrm{BG}=0 \mathrm{~V}$. All AC Parameters are specified at $600 \Omega 2$ Wire Terminating Impedance

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| AC TRANSMISSION PARAMETERS |  |  |  |  |  |
| RX Input Impedance | 300 Hz to 3.4 kHz (Note 4) | - | 100 | - | $\mathrm{k} \Omega$ |
| TX Output Impedance | 300 Hz to 3.4 kHz (Note 4) | - | - | 20 | $\Omega$ |
| 4-Wire Input Overload Level | 300 Hz to $3.4 \mathrm{kHz} \mathrm{R}_{\mathrm{L}}=1200 \Omega$, 600』 Reference | 1.5 | - | - | V PEAK |
| 2-Wire Return Loss SRL LO | Matched for $600 \Omega$ (Note 4) | 26 | 35 | - | dB |
| ERL |  | 30 | 40 | - | dB |
| SRL HI |  | 30 | 40 | - | dB |
| 2-Wire Longitudinal to Metallic Balance Off Hook | Per ANSI/IEEE STD 455-1976 (Note 4) 300Hz to 3400 Hz | 58 | 63 | - | dB |
| 4-Wire Longitudinal Balance Off Hook | 300 Hz to 3400Hz (Note 4) | 50 | 55 | - | dB |
| Low Frequency Longitudinal Balance | R.E.A. Test Circuit | - | - | -67 | dBmp |
|  | $\mathrm{I}_{\text {LINE }}=40 \mathrm{~mA}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (Note 4) | - | - | 23 | dBrnC |
| Longitudinal Current Capability | $\mathrm{l}_{\text {LINE }}=40 \mathrm{~mA}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ ( Note 4) | - | - | 30 | mA ${ }_{\text {RMS }}$ |
| Insertion Loss 2-Wire/4-Wire | 0 dBm at 1 kHz , Referenced $600 \Omega$ | - | $\pm 0.05$ | $\pm 0.2$ | dB |
| 4-Wire/2-Wire |  | - | $\pm 0.05$ | $\pm 0.2$ | dB |
| 4-Wire/4-Wire |  | - | - | $\pm 0.2$ | dB |
| Frequency Response | 300 Hz to 3400 Hz (Note 4) Referenced to Absolute Level at 1 kHz , 0 dBm Referenced $600 \Omega$ | - | $\pm 0.02$ | $\pm 0.05$ | dB |
| Level Linearity <br> 2-Wire to 4-Wire and 4-Wire to 2-Wire | $\begin{aligned} & \text { Referenced to }-10 \mathrm{dBm}(\text { Note } 4) \\ & +3 \text { to }-40 \mathrm{dBm} \end{aligned}$ | - | - | $\pm 0.05$ | dB |
|  | -40 to -50dBm | - | - | $\pm 0.1$ | dB |
|  | -50 to -55dBm | - | - | $\pm 0.3$ | dB |

## Electrical Specifications

Unless Otherwise Specified, Typical Parameters are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, Min-Max Parameters are Over Operating Temperature Range, $\mathrm{V}_{\mathrm{B}-}=-48 \mathrm{~V}, \mathrm{~V}_{\mathrm{B}+}=5 \mathrm{~V}, \mathrm{AG}=\mathrm{DG}=\mathrm{BG}=0 \mathrm{~V}$. All AC Parameters are specified at $600 \Omega 2$ Wire Terminating Impedance (Continued)

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Absolute Delay 2-Wire/4-Wire | (Note 4) <br> 300 Hz to 3400 Hz | - | - | 1 | $\mu \mathrm{s}$ |
| 4-Wire/2-Wire | 300 Hz to 3400 Hz | - | - | 1 | $\mu \mathrm{s}$ |
| 4-Wire/4-Wire | 300 Hz to 3400Hz | - | - | 1.5 | $\mu \mathrm{s}$ |
| Transhybrid Loss, THL | (Note 4) See Figure 1 | - | 40 | - | dB |
| Total Harmonic Distortion <br> 2-Wire/4-Wire, 4-Wire/2-Wire, 4-Wire/4-Wire | Reference Level 0 dBm at $600 \Omega$ 300 Hz to 3400 Hz (Note 4) | - | - | -52 | dB |
| Idle Channel Noise 2-Wire and 4-Wire | (Note 4) <br> C-Message | - | - | 5 | dBrnC |
|  | Psophometric | - | - | -85 | dBmp |
|  | 3 kHz Flat | - | - | 15 | dBrn |
| Power Supply Rejection Ratio $\mathrm{V}_{\mathrm{B}+} \text { to 2-Wire }$ | $\begin{aligned} & \text { (Note 4) } \\ & 30 \mathrm{~Hz} \text { to } 200 \mathrm{~Hz}, \mathrm{R}_{\mathrm{L}}=600 \Omega \end{aligned}$ | 20 | 29 | - | dB |
| $\mathrm{V}_{\mathrm{B}_{+}}$to 4-Wire |  | 20 | 29 | - | dB |
| $\mathrm{V}_{\mathrm{B} \text { - }}$ to 2-Wire |  | 20 | 29 | - | dB |
| $\mathrm{V}_{\mathrm{B} \text { - }}$ to 4-Wire |  | 20 | 29 | - | dB |
| $\mathrm{V}_{\mathrm{B}_{+}}$to 4-Wire | $\begin{aligned} & \text { (Note 4) } \\ & 200 \mathrm{~Hz} \text { to } 16 \mathrm{kHz}, \mathrm{R}_{\mathrm{L}}=600 \Omega \end{aligned}$ | 30 | - | - | dB |
| $\mathrm{V}_{\mathrm{B} \text { - }}$ to 2-Wire |  | 30 | - | - | dB |
| $\mathrm{V}_{\mathrm{B} \text { - }}$ to 4-Wire |  | 20 | 25 | - | dB |
| $\mathrm{V}_{\mathrm{B} \text { - }}$ to 4-Wire |  | 20 | 25 | - | dB |
| Ring Sync Pulse Width |  | 50 | - | 500 | $\mu \mathrm{s}$ |
| DC PARAMETERS |  |  |  |  |  |
| Loop Current Programming Limit Range |  | 20 | - | 60 | mA |
| Accuracy |  | 10 | - | - | \% |
| Loop Current During Power Denial | $\mathrm{R}_{\mathrm{L}}=200 \Omega$ | - | $\pm 3$ | $\pm 5$ | mA |
| Fault Currents TIP to Ground |  | - | 30 | - | mA |
| RING to Ground |  | - | 60 | - | mA |
| TIP and RING to Ground |  | - | 90 | - | mA |
| Switch Hook Detection Threshold |  | - | 12 | 15 | mA |
| Ground Key Detection Threshold |  | - | 10 | - | mA |
| Thermal $\overline{\text { ALARM Output }}$ | Safe Operating Die Temperature Exceeded | 140 | - | 160 | ${ }^{\circ} \mathrm{C}$ |
| Ring Trip Detection Threshold | $\mathrm{V}_{\text {RING }}=105 \mathrm{~V}_{\text {RMS }}, \mathrm{f}_{\text {RING }}=20 \mathrm{~Hz}$ | - | 10 | - | mA |
| Ring Trip Detection Period |  | - | 100 | 150 | ms |
| Dial Pulse Distortion |  | - | 0.1 | 0.5 | ms |
| Relay Driver Outputs On Voltage $\mathrm{V}_{\mathrm{OL}}$ |  | - | 0.2 | 0.5 | V |
| Off Leakage Current | $\mathrm{V}_{\mathrm{OH}}=13.2 \mathrm{~V}$ | - | $\pm 10$ | $\pm 100$ | $\mu \mathrm{A}$ |
| TTL/CMOS Logic Inputs (F0, F1, RS, TEST, PRI) Logic '0’ $\mathrm{V}_{\mathrm{IL}}$ |  | - | - | 0.8 | V |
| Logic '1' $\mathrm{V}_{\mathrm{IH}}$ |  | 2.0 | - | 5.5 | V |
| Input Current (F0, F1, RS, TEST, PRI) | $0 \mathrm{~V} \leq \mathrm{V}_{\text {IN }} \leq 5 \mathrm{~V}$ | - | - | $\pm 100$ | $\mu \mathrm{A}$ |
| Logic Outputs Logic '0' $\mathrm{V}_{\mathrm{OL}}$ | $\mathrm{L}_{\text {LOAD }}=800 \mu \mathrm{~A}$ | - | 0.1 | 0.5 | V |
| Logic '1' $\mathrm{V}_{\mathrm{OH}}$ | LIOAD $=40 \mu \mathrm{~A}$ | 2.7 | - | - | V |

## Electrical Specifications

Unless Otherwise Specified, Typical Parameters are at $T_{A}=25^{\circ} \mathrm{C}$, Min-Max Parameters are Over Operating Temperature Range, $\mathrm{V}_{\mathrm{B}-}=-48 \mathrm{~V}, \mathrm{~V}_{\mathrm{B}+}=5 \mathrm{~V}, \mathrm{AG}=\mathrm{DG}=\mathrm{BG}=0 \mathrm{~V}$. All AC Parameters are specified at $600 \Omega 2$ Wire Terminating Impedance (Continued)

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNITS |
| :--- | :--- | :---: | :---: | :---: | :---: |
| Power Dissipation On Hook | Relay Drivers Off | - | 200 | - | mW |
| $\mathrm{I}_{\mathrm{B}^{+}}$ | $\mathrm{V}_{\mathrm{B}_{+}=5.25 \mathrm{~V}, \mathrm{~V}_{\mathrm{B}-}=-58 \mathrm{~V}, \mathrm{R}_{\mathrm{LOOP}}=\infty}$ | - | - | 6 | mA |
| $\mathrm{I}_{\mathrm{B}^{-}}$ | $\mathrm{V}_{\mathrm{B}_{+}=5.25 \mathrm{~V}, \mathrm{~V}_{\mathrm{B}^{-}}=-58 \mathrm{~V}, \mathrm{R}_{\mathrm{LOOP}}=\infty}$ | -6 | - | - | mA |
| UNCOMMITTED OP AMP PARAMETERS |  | - | $\pm 5$ | - | mV |
| Input Offset Voltage |  | - | $\pm 10$ | - | nA |
| Input Offset Current | (Note 4) | - | 1 | - | $\mathrm{M} \Omega$ |
| Differential Input Resistance | $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ | - | $\pm 3$ | - | $\mathrm{V}_{\mathrm{P}-\mathrm{P}}$ |
| Output Voltage Swing | Note 4) | - | 1 | - | MHz |
| Small Signal GBW |  |  |  |  |  |

NOTE:
4. These parameters are controlled by design or process parameters and are not directly tested. These parameters are characterized upon initial design release, upon design changes which would affect these characteristics, and at intervals to assure product quality and specification compliance.

## Pin Descriptions

| DIP/SOIC | PLCC | SYMBOL | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| 1 | 2 | $\begin{gathered} \text { AG } \\ \text { (Note 5) } \end{gathered}$ | Analog Ground - To be connected to zero potential. Serves as a reference for the transmit output and receive input terminals. |
| 2 | 3 | $\mathrm{V}_{\mathrm{B}^{+}}$ | Positive Voltage Source - most positive supply. |
| 3 | 4 | $\mathrm{C}_{1}$ | Capacitor \# $\mathrm{C}_{1}$ - An external capacitor to be connected between this terminal and analog ground. Required for proper operation of the loop current limiting function. |
| 4 | 8 | F1 | Function Address \#1 - A TTL and CMOS compatible input used with FO function address line to externally select logic functions. The three selectable functions are mutually exclusive. See Truth Table. F1 should be toggled high after power is applied. |
| 5 | 9 | F0 | Function Address \#0 - A TTL and CMOS compatible input used with F1 function address line to externally select logic functions. The three selectable functions are mutually exclusive. See Truth Table. |
| 6 | 10 | RS | Ring Synchronization Input - A TTL - compatible clock input. The clock is arranged such that a positive pulse ( $50 \mu \mathrm{~s}-500 \mu \mathrm{~s}$ ) occurs on the zero crossing of the ring voltage source, as it appears at the RFS terminal. For Tip side injected systems, the RS pulse should occur on the negative going zero crossing and for Ring injected systems, on the positive going zero crossing. This ensures that the ring delay activates and deactivates when the instantaneous ring voltage is near zero. If synchronization is not required, the pin should be tied to 5 . |
| 7 | 11 | $\overline{\text { SHD }}$ | Switch Hook Detection - An active low LS, TTL-compatible logic output. A line supervisory output. |
| 8 | 12 | $\overline{\mathrm{GKD}}$ | Ground Key Detection - An active low LS, TTL-compatible logic output. A line supervisory output. |
| 9 | 13 | $\overline{\text { TST }}$ | A TTL logic input. A low on this pin will set a latch and keep the SLIC in a power down mode until the proper F1, F0 state is set and will keep ALM low. See Truth Table. |
| 10 | 17 | $\overline{\text { ALM }}$ | An LS TTL-compatible active low output which responds to the thermal detector circuit when a safe operating die temperature has been exceeded. When TST is forced low by an external control signal, $\overline{\text { ALM }}$ is latched low until the proper F1, F0 state and TST input is brought high. The $\overline{\text { ALM can be tied directly to }}$ the TST pin to power down the part when a thermal fault is detected and then reset with F0, F1. See Truth Table. It is possible to ignore transient thermal overload conditions in the SLIC by delaying the response to the TST pin from the ALM. Care must be exercised in attempting this as continued thermal overstress may reduced component life. |
| 11 | 18 | ILMT | Loop Current Limit - Voltage on this pin sets the short loop current limiting conditions using a resistive voltage divider. |
| 12 | 19 | OUT1 | The analog output of the spare operational amplifier. |

## Pin Descriptions (Continued)

| DIP/SOIC | PLCC | SYMBOL | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| 13 | 20 | -IN1 | The inverting analog input of the spare operational amplifier. |
| 14 | 22 | TIP | An analog input connected to the TIP (more positive) side of the subscriber loop through a feed resistor and ring relay contact. Functions with the RING terminal to receive voice signals from the telephone and for loop monitoring purpose. |
| 15 | 24 | RING | An analog input connected to the RING (more negative) side of the subscriber loop through a feed resistor. Functions with the TIP terminal to receive voice signals from the telephone and for loop monitoring purposes. |
| 16 | 25 | RFS | Ring Feed Sense - Senses RING side of the loop for Ground Key Detection. During Ring injected ringing the ring signal at this node is isolated from RF via the ring relay. For Tip injected ringing, the RF and RFS pins must be shorted. |
| 17 | 27 | $\mathrm{V}_{\mathrm{RX}}$ | Receive Input, 4-Wire Side - A high impedance analog input. AC signals appearing at this input drive the Tip Feed and Ring Feed amplifiers differentially. |
| 18 | 31 | $\mathrm{C}_{2}$ | Capacitor \#C2 - An external capacitor to be connected between this terminal and ground. It prevents false ring trip detection from occurring when longitudinal currents are induced onto the subscriber loop from power lines and other noise sources. This capacitor should be nonpolarized. |
| 19 | 32 | $\mathrm{V}_{\mathrm{TX}}$ | Transmit Output, 4-Wire Side - A low impedance analog output which represents the differential voltage across TIP and RING. Transhybrid balancing must be performed beyond this output to completely implement 2-Wire to 4-Wire conversion. This output is referenced to analog ground. Since the DC level of this output varies with loop current, capacitive coupling to the next stage is necessary. |
| 20 | 33 | PRI | A TTL compatible input used to control $\overline{\mathrm{PR}}$. PRI active High $=\overline{\mathrm{PR}}$ active low. |
| 21 | 34 | $\overline{\mathrm{PR}}$ | An active low open collector output. Can be used to drive a Polarity Reversal Relay. |
| 22 | 35 | $\begin{gathered} \hline \text { DG } \\ (\text { Note 5) } \end{gathered}$ | Digital Ground - To be connected to zero potential. Serves as a reference for all digital inputs and outputs on the SLIC. |
| 23 | 36 | $\overline{\mathrm{RD}}$ | Ring Relay Driver - An active low open collector output. Used to drive a relay that switches ringing signals onto the 2-Wire line. |
| 24 | 37 | $\mathrm{V}_{\mathrm{FB}}$ | Feedback input to the tip feed amplifier; may be used in conjunction with transmit output signal and the spare op amp to accommodate 2-Wire line impedance matching. |
| 25 | 38 | $\mathrm{TF}_{2}$ | Tip Feed - A low impedance analog output connected to the TIP terminal through a feed resistor. Functions with the RF terminal to provide loop current, and to feed voice signals to the telephone set and to sink longitudinal currents. Must be tied to $\mathrm{TF}_{1}$. |
| NA | 39 | $\mathrm{TF}_{1}$ | Tie directly to $\mathrm{TF}_{2}$ in the PLCC application. |
| 26 | 41 | $\mathrm{RF}_{1}$ | Ring Feed - A low impedance analog output connected to the RING terminal through a feed resistor. Functions with the TF terminal to provide loop current, feed voice signals to the telephone set, and to sink longitudinal currents. Tie directly to $\mathrm{RF}_{2}$. |
| NA | 42 | $\mathrm{RF}_{2}$ | Tie directly to $\mathrm{RF}_{1}$ in the PLCC application. |
| 27 | 43 | $\mathrm{V}_{\mathrm{B}}{ }^{-}$ | The battery voltage source. The most negative supply. |
| 28 | 44 | BG (Note 5) | Battery Ground - To be connected to zero potential. All loop current and some quiescent current flows into this ground terminal. |
|  | $\begin{gathered} 1,5,6,7, \\ 14,15,16, \\ 21,23,26, \\ 28,29,30, \\ 40 \end{gathered}$ | NC | No internal connection. |

NOTE:
5. All grounds ( $\mathrm{AG}, \mathrm{BG}$, and DG ) must be applied before $\mathrm{V}_{\mathrm{B}_{+}}$or $\mathrm{V}_{\mathrm{B} \text {-. Failure to }}$ do so may result in premature failure of the part. If a user wishes to run separate grounds off a line card, the AG must be applied first.

## Pinouts

HC-5509B (PDIP, SOIC)
TOP VIEW


TRUTH TABLE

| F1 | F0 | ACTION |
| :---: | :---: | :--- |
| 0 | 0 | Normal Loop Feed |
| 0 | 1 | $\overline{\text { RD Active (Ringing) }}$ |
| 1 | 0 | Power Down Latch <br> RESET |
| 1 | 0 | Power On RESET |
| 1 | 1 | Loop Power Denial <br> Active |

HC-5509B (PLCC)
TOP VIEW


Functional Diagram


Functional Diagram (Continued)


NC = 1, 5, 6, 7, 14, 15, 16, 21, 23, 26, 28, 29, 30, 40

## Overvoltage Protection and Longitudinal Current Protection

The SLIC device, in conjunction with an external protection bridge, will withstand high voltage lightning surges and power line crosses.

High voltage surge conditions are as specified in Table 1.
The SLIC will withstand longitudinal currents up to a maximum or $30 \mathrm{~mA}_{\text {RMS }}, 15 \mathrm{~mA}_{\text {RMS }}$ per leg, without any performance degradation.

TABLE 1.

| PARAMETER | TEST <br> CONDITION | PERFORMANCE <br> (MAX) | UNITS |
| :--- | :--- | :--- | :--- |
| Longitudinal <br> Surge | $10 \mu \mathrm{~s}$ Rise/ <br> $1000 \mu \mathrm{~s}$ Fall | $\pm 1000$ (Plastic) | $\mathrm{V}_{\text {PEAK }}$ |
| Metallic Surge | $10 \mu \mathrm{~s}$ Rise/ <br> $1000 \mu \mathrm{~s}$ Fall | $\pm 1000$ (Plastic) | $\mathrm{V}_{\text {PEAK }}$ |
| T/GND, R/GND | $10 \mu \mathrm{~s}$ Rise/ <br> $1000 \mu \mathrm{~s}$ Fall | $\pm 1000$ (Plastic) | $\mathrm{V}_{\text {PEAK }}$ |
| $50 / 60 \mathrm{~Hz}$ Current <br> T/GND, <br> R/GND | 11 Cycles, <br> Limited to <br> $10 A_{\text {RMS }}$ | 700 (Plastic) | $\mathrm{V}_{\text {RMS }}$ |

## Logic Diagram




## Typical Applications



FIGURE 1. TYPICAL LINE CIRCUIT APPLICATION WITH THE MONOLITHIC SLIC

## Typical Component Values

$\mathrm{C}_{1}=0.5 \mu \mathrm{~F}, 30 \mathrm{~V}$
$\mathrm{C}_{2}=1.0 \mu \mathrm{~F} \pm 10 \%, 20 \mathrm{~V}$ (for other values of $\mathrm{C}_{2}$, refer to AN9667)
$\mathrm{C}_{3}=0.01 \mu \mathrm{~F}, 100 \mathrm{~V}, \pm 20 \%$
$\mathrm{C}_{4}=0.01 \mu \mathrm{~F}, 100 \mathrm{~V}, \pm 20 \%$
$\mathrm{C}_{5}=0.01 \mu \mathrm{~F}, 100 \mathrm{~V}, \pm 20 \%$
$C_{A C}=0.5 \mu \mathrm{~F}, 20 \mathrm{~V}$
$K Z_{0}=60 \mathrm{k} \Omega,\left(Z_{0}=600 \Omega, \mathrm{~K}=\right.$ Scaling Factor $\left.=100\right)$
$R_{L 1}, R_{L 2}$; Current Limit Setting Resistors:
$R_{L 1}+R_{L 2}>90 k \Omega \rightarrow$ offset
limit $=(0.6)\left(R_{L 1}+R_{L 2}\right) /\left(200 \times R_{L 2}\right), R_{L 1}$ typically $100 k \Omega$
$K_{R F}=20 k \Omega, R F=2\left(R_{B 2}+R_{B 4}\right), K=$ Scaling Factor $\left.=100\right)$
$R_{B 1}=R_{B 2}=R_{B 3}=R_{B 4}=50 \Omega$ (1\% absolute, matching requirements covered in a Tech Brief)
$R_{S 1}=R_{S 2}=1 k \Omega$, typically
$\mathrm{C}_{\mathrm{S} 1}=\mathrm{C}_{\mathrm{S} 2}=0.1 \mu \mathrm{~F}, 200 \mathrm{~V}$ typically, depending on $\mathrm{V}_{\text {Ring }}$ and line length.
$\mathrm{Z}_{1}=150 \mathrm{~V}$ to 200 V transient protector. PTC used as ring generator ballast.

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